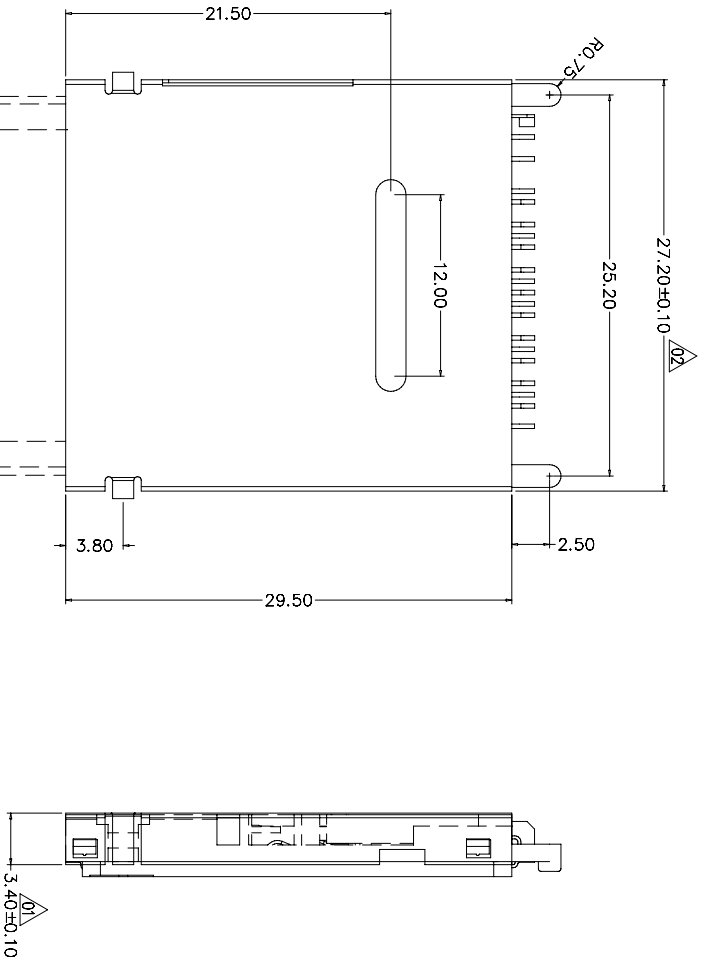
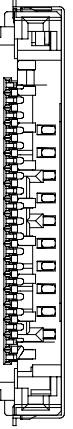


NOTES :  
 MATERIAL : HIGH TEMPERATURE THERMOPLASTIC , UL94V-0.  
 INSULATOR :  
 COLOR : BLACK  
 CONTACT : PHOSPHOR BRONZE.  
 PLATING : CONTACT AREA : 10.4μ" Au PLATED OVER Ni  
 SOLDER AREA : Tin PLATED OVER Ni  
 Application : SD,HS SD,SDHC,MMC,xD,MS,MS PRO  
 MagicGate MS,MS-ROM,MS I/O Expansion Card  
 (It can protect the damage of MSDuo)



xD CARD  
 SD & HS SD & SDHC & MMC & MMCplus CARD  
 MS & MS PRO & MagicGate MS & MS-ROM & MS I/O Expansion CARD  
 MS-ROM & MS I/O Expansion CARD



— Tolerances — Unless Otherwise Specified		BroadTek Technology CO., LTD.		Title : Multi Card Connector (MMC)	
.0	±0.15	Approved: Kerwin	Checked: Jim	Drawing NO. E-430-411-111	Part NO. E-430-411-111
.000	±0.05	Engineer: Angus	Drawn: Rita	Unit: mm	Scale: 2:1
ANGLES	±1°			Size A4	Rev. Sheet 01